



Micro Commercial Components  
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## 1N4148W

### Features

- Fast Switching Speed
- Surface Mount Package Ideally Suited for Automatic Insertion
- For General Purpose Switching Applications
- High Conductance

### Mechanical Data

- Case: SOD-123, Molded Plastic
- Terminals: Solderable per MIL-STD-202, Method 208
- Polarity: Indicated by Cathode Band
- Weight: 0.01 grams ( approx.)

#### Maximum Ratings @ 25°C Unless Otherwise Specified

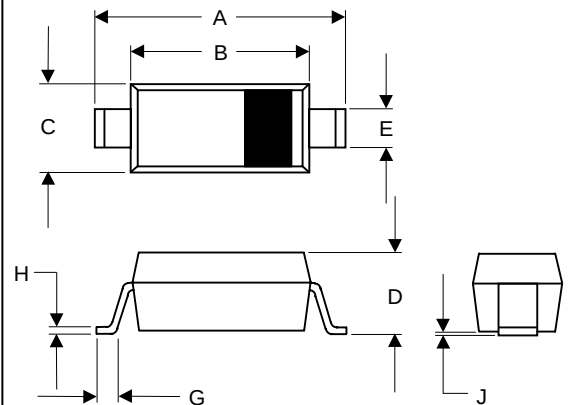
| Characteristic                        | Symbol         | Value       | Unit |
|---------------------------------------|----------------|-------------|------|
| Non-Repetitive Peak Reverse Volt.     | $V_{RM}$       | 100         | V    |
| Peak Repetitive Reverse Voltage       | $V_{RRM}$      | 75          | V    |
| Working Peak Reverse Voltage          | $V_{RWM}$      |             |      |
| DC Blocking Voltage                   | $V_R$          |             |      |
| RMS Reverse Voltage                   | $V_{R(RMS)}$   | 53          | V    |
| Forward Continuous Current(Note1)     | $I_{FM}$       | 300         | mA   |
| Average Rectified Output Current      | $I_o$          | 150         | mA   |
| Non-Repetitive Peak @ $t \leq 1.0s$   | $I_{FSM}$      | 2           | A    |
| Forward Surge Current @ $t = 10\mu s$ |                | 1           | A    |
| Power Dissipation(Note 1)             | $P_d$          | 500         | mW   |
| Thermal Resistance(Note 1)            | $R$            | 315         | K/W  |
| Operation/Storage Temp. Range         | $T_j, T_{STG}$ | -55 to +150 | °C   |

#### Electrical Characteristics @ 25°C Unless Otherwise Specified

| Charateristic                | Symbol   | Max   | Unit    | Test Cond.                                         |
|------------------------------|----------|-------|---------|----------------------------------------------------|
| Maximum Forward Voltage Drop | $V_{FM}$ | 0.715 | V       | $I_F = 1.0mA$                                      |
|                              |          | 0.855 |         | $I_F = 10mA$                                       |
|                              |          | 1     |         | $I_F = 50mA$                                       |
|                              |          | 1.25  |         | $I_F = 150mA$                                      |
| Maximum Peak Reverse Current | $I_{RM}$ | 5.0   | $\mu A$ | $V_R = 75V, T_j = 25^\circ C$                      |
|                              |          | 50    | $\mu A$ | $V_R = 25V, T_j = 150^\circ C$                     |
|                              |          | 25    | nA      | $V_R = 20V$                                        |
| Junction Capacitance         | $C_j$    | 4     | pF      | $V_R = 0V, f = 1.0MHz$                             |
| Reverse Recovery Time        | $t_{rr}$ | 4     | ns      | $I_F = I_R = 50mA, I_{rr} = 0.1I_R, R_L = 100 OHM$ |

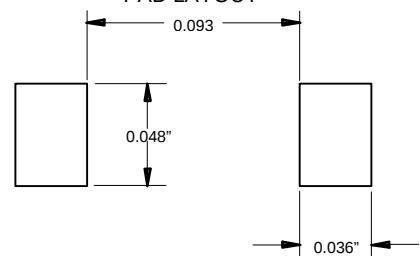
### High Speed Switching Diode 500mW

#### SOD123



| DIM | INCHES |       | MM    |       | NOTE |
|-----|--------|-------|-------|-------|------|
|     | MIN    | MAX   | MIN   | MAX   |      |
| A   | .140   | .152  | 3.55  | 3.85  |      |
| B   | .100   | .112  | 2.55  | 2.85  |      |
| C   | .055   | .071  | 1.40  | 1.80  |      |
| D   | -----  | .053  | ----- | 1.35  |      |
| E   | .012   | .031  | 0.30  | .78   |      |
| G   | .006   | ----- | 0.15  | ----- |      |
| H   | -----  | .01   | ----- | .25   |      |
| J   | -----  | .006  | ----- | .15   |      |

#### SUGGESTED SOLDER PAD LAYOUT



**Note:** 1. Valid provided that terminals are kept at ambient temperature

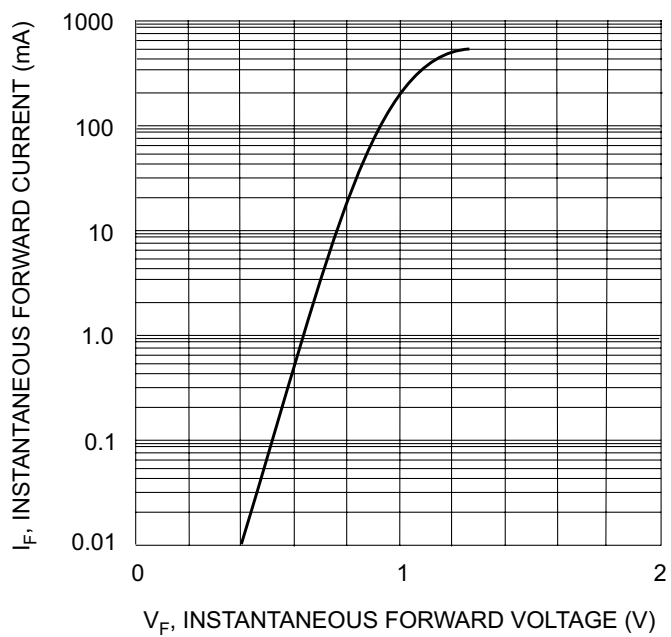


Fig. 1 Forward Characteristics

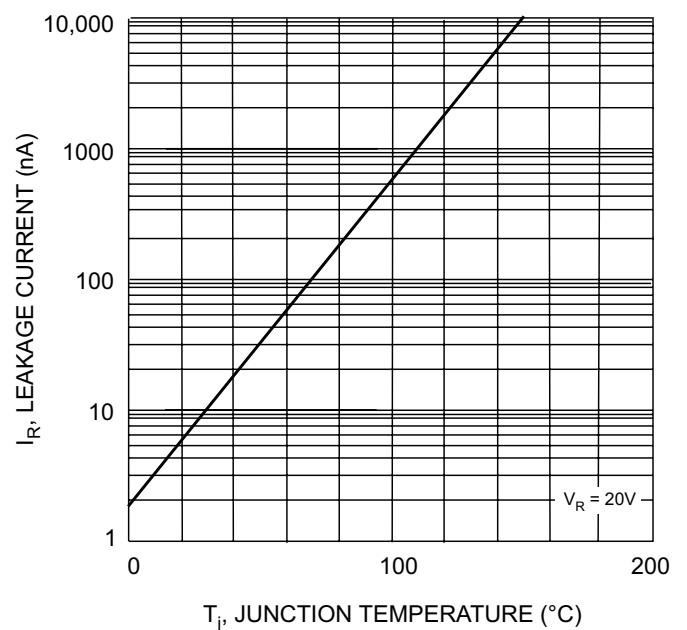


Fig. 2 Leakage Current vs Junction Temperature